



SMT inductors

SIMID series, SIMID 1210-100

Series/Type: **B82422A*100**

Date: September 2019

SMD

Size 1210 (EIA) or 3225 (IEC)
Rated inductance 0.0082 ... 100 μ H
Rated current 65 ... 800 mA



Construction

- Ceramic or ferrite core
- Laser-welded winding
- Flame-retardant molding

Features

- Temperature range up to +145 °C
- High Q factor
- High resonance frequency
- Qualified to AEC-Q200
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD 020D
- RoHS-compatible

Applications

- Filtering of supply voltages, coupling, decoupling
- Antenna systems
- Automotive electronics
- Telecommunications
- Consumer and data processing equipment
- Industrial electronics

Terminals

- Base material CuSn6
- Layer composition Cu, Ag, Sn (lead-free)¹⁾
- Electro-plated

Marking

- Marking on component:
 Manufacturer, L value (in nH),
 tolerance of L value (coded), date of manufacture (YWWD)
- Minimum data on reel:
 Manufacturer, ordering code, L value,
 quantity, date of packing

Delivery mode and packing units

- 8-mm blister tape, wound on 180-mm or 330-mm \varnothing reel
- Packing units:
 180-mm reel: 2000 pcs./reel
 330-mm reel: 8000 pcs./reel

1) Ni-barrier-plated terminals on request (B82422A*150).

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Technical data and measuring conditions

Rated inductance L_R	Measured with impedance analyzer Agilent 4294A or equivalent at frequency f_L , 0.1 V, +20 °C
Q factor Q_{min}	Measured with impedance analyzer Agilent 4294A or equivalent at frequency f_Q , +20 °C
Rated temperature T_R	+125 °C
Rated current I_R	Maximum permissible DC with inductance decrease $\Delta L/L_0 \leq 10\%$ and temperature increase of ≤ 20 K at rated temperature
Self-resonance frequency $f_{res,min}$	Measured with impedance analyzer Agilent E4991A / network analyzer Agilent E8362B or equivalent at +20 °C
DC resistance R_{max}	Measured at +20 °C
Solderability (lead-free)	Sn95.5Ag3.8Cu0.7: +(245 ±5) °C, (5 ±0.3) s Wetting of soldering area $\geq 90\%$ (based on IEC 60068-2-58)
Resistance to soldering heat	+260 °C, 40 s (as referenced in JEDEC J-STD 020D)
Climatic category	55/150/56 (to IEC 60068-1)
Storage conditions	Mounted: -55 °C ... +150 °C Packaged: -25 °C ... +40 °C, $\leq 75\%$ RH
Weight	Approx. 50 mg

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Characteristics and ordering codes

L_R μH	Tolerance	f_L MHz	Q_{\min}	f_Q MHz	I_R mA	R_{\max} Ω	$f_{\text{res, min}}$ MHz	Ordering code ¹⁾²⁾ (\varnothing 180-mm reel)
Core material: ceramic								
0.0082	$\pm 5\% \triangleq J$	10	20	100	800	0.08	4000	B82422A3829+100
0.010	$\pm 10\% \triangleq K$	10	20	100	750	0.09	4000	B82422A3100+100
0.012		10	25	100	700	0.10	3500	B82422A3120+100
0.015	$\pm 10\% \triangleq K$	10	27	100	640	0.12	3000	B82422A3150+100
0.018		10	30	100	640	0.12	2500	B82422A3180+100
0.022		10	30	100	600	0.14	2500	B82422A3220+100
0.027		10	23	50	600	0.14	1850	B82422A3270+100
0.033		10	20	50	540	0.17	1700	B82422A3330+100
0.039		10	25	50	530	0.18	1450	B82422A3390+100
0.047		10	26	50	510	0.19	1350	B82422A3470+100
0.056		10	26	50	500	0.20	1200	B82422A3560+100
0.068		10	27	50	480	0.21	1150	B82422A3680+100
0.082		10	27	50	450	0.24	1050	B82422A3820+100
0.10		10	25	50	440	0.26	1000	B82422A3101+100
0.12		1	22	30	400	0.32	880	B82422A3121+100
0.15		1	25	30	390	0.33	850	B82422A3151+100
0.18		1	25	30	360	0.38	800	B82422A3181+100
0.22		1	25	30	280	0.64	700	B82422A3221+100
0.27	1	20	30	235	0.90	650	B82422A3271+100	
0.33	1	22	30	200	1.3	580	B82422A3331+100	
0.39	1	22	30	190	1.4	540	B82422A3391+100	
0.47	1	22	30	150	2.2	480	B82422A3471+100	
0.56	1	22	30	150	2.2	400	B82422A3561+100	
0.68	1	22	30	145	2.4	280	B82422A3681+100	
0.82	1	22	30	140	2.5	240	B82422A3821+100	

Closer tolerances and special versions on request.

Higher currents possible at temperatures $<T_R$ on request.

Sample kit available. Ordering code: B82422X100

For more information refer to chapter "Sample kits".

1) Replace the + by the code letter for the required inductance tolerance.

For reel size \varnothing 330 mm the last digit has to be an »8«. Example: B82422A3829K108

2) For Ni-barrier-plated terminals replace the last three digits "100" by "150" (reel 180 mm) or "158" (reel 330 mm).

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Characteristics and ordering codes

L_R μH	Tolerance	f_L MHz	Q_{\min}	f_Q MHz	I_R mA	R_{\max} Ω	$f_{\text{res, min}}$ MHz	Ordering code ¹⁾²⁾ (\varnothing 180-mm reel)
Core material: ferrite								
1.0	$\pm 5\% \triangleq J$	1	20	7.96	380	0.34	320	B82422A1102+100
1.2	$\pm 10\% \triangleq K$	1	20	7.96	370	0.37	300	B82422A1122+100
1.5		1	20	7.96	340	0.50	270	B82422A1152+100
1.8	$\pm 10\% \triangleq K$	1	25	7.96	290	0.60	250	B82422A1182+100
2.2		1	25	7.96	270	0.75	125	B82422A1222+100
2.7		1	25	7.96	240	0.88	110	B82422A1272+100
3.3		1	27	7.96	200	1.20	110	B82422A1332+100
3.9		1	27	7.96	190	1.40	110	B82422A1392+100
4.7		1	27	7.96	150	2.20	110	B82422A1472+100
5.6		1	27	7.96	140	2.60	100	B82422A1562+100
6.8		1	27	7.96	135	2.80	90	B82422A1682+100
8.2		1	27	7.96	130	3.00	90	B82422A1822+100
10		1	27	2.52	180	1.60	25	B82422A1103+100
12	0.1	27	2.52	175	1.65	23	B82422A1123+100	
15	0.1	27	2.52	165	1.85	20	B82422A1153+100	
18	0.1	27	2.52	155	2.00	17	B82422A1183+100	
22	0.1	27	2.52	140	2.65	16	B82422A1223+100	
27	0.1	27	2.52	120	3.70	15	B82422A1273+100	
33	0.1	27	2.52	105	4.50	13	B82422A1333+100	
39	0.1	27	2.52	90	6.30	12	B82422A1393+100	
47	0.1	27	2.52	85	7.00	11	B82422A1473+100	
56	0.1	27	2.52	85	6.75	9	B82422A1563+100	
68	0.1	27	2.52	80	7.70	9	B82422A1683+100	
82	0.1	27	2.52	70	10.0	8	B82422A1823+100	
100	0.1	27	2.52	65	11.5	7	B82422A1104+100	

Closer tolerances and special versions on request.

Higher currents possible at temperatures $<T_R$ on request.

Sample kit available. Ordering code: B82422X100

For more information refer to chapter "Sample kits".

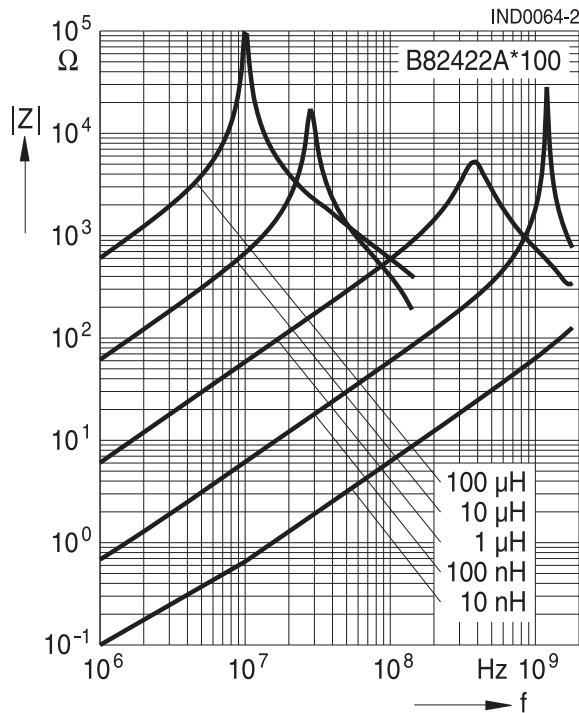
1) Replace the + by the code letter for the required inductance tolerance.

For reel size \varnothing 330 mm the last digit has to be an »8«. Example: B82422A1104K108

2) For Ni-barrier-plated terminals replace the last three digits "100" by "150" (reel 180 mm) or "158" (reel 330 mm).

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Impedance $|Z|$ versus frequency f
measured with impedance analyzer Agilent E4991A, typical values at +20 °C



Inductance L versus DC load current I_{DC}
measured with LCR meter Agilent 4285A, typical values at +20 °C



Q factor versus frequency f
measured with impedance analyzer Agilent 4294A/E4991A, typical values at +20 °C



Current derating I_{op}/I_R versus ambient temperature T_A
(rated temperature $T_R = +125$ °C)



Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire, wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
 - Many coating materials have a negative effect (chemically and mechanically) on the winding wires, insulation materials and connecting points. Customers are always obligated to determine whether and to what extent their coating materials influence the component.
Customers are responsible and bear all risk for the use of the coating material. TDK Electronics does not assume any liability for failures of our components that are caused by the coating material.
- Ceramics / ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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